

Global and China Die Bonder Equipment Market Research by Company, Type & Application 2013-2025

<https://marketpublishers.com/r/G6E0F88AEDAEN.html>

Date: August 2019

Pages: 72

Price: US\$ 2,000.00 (Single User License)

ID: G6E0F88AEDAEN

Abstracts

SUMMARY

Die bonding is the process of attaching a die/chip to a substrate or package. Die bonding is accomplished by using one of the following processes: 1. Eutectic; 2. Solder; 3. Adhesive; 4. Glass or Silver-Glass

Market Segment as follows:

By Type

Fully Automatic

Semi-Automatic

Manual

By Application

Integrated Device Manufacturers (IDMs)

Outsourced Semiconductor Assembly and Test (OSAT)

By Company

Besi

ASM Pacific Technology (ASMPT)

Kulicke & Soffa

Palomar Technologies

Shinkawa

DIAS Automation

Toray Engineering

Panasonic

FASFORD TECHNOLOGY

West-Bond

Hybond

The main contents of the report including:

Section 1:

Product definition, type and application, global and China market overview;

Section 2:

Global and China Market competition by company;

Section 3:

Global and China sales revenue, volume and price by type;

Section 4:

Global and China sales revenue, volume and price by application;

Section 5:

China export and import;

Section 6:

Company information, business overview, sales data and product specifications;

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Industry chain and raw materials;

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